# DATASHEET

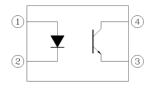
# 4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL816(SG)(BY)-G Series



## **Preliminary**

This is a preliminary specification Intended for design purposes and Subject to change without prior notice.

#### Schematic



#### Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector

#### Features:

- Compliance Halogens Free (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)</li>
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +110°C
- •The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved
- State Grid approved
- MSL1

#### Description

The EL816(SG)(BY)-G series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector.

#### Applications

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

## Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
	Forward current	١ <sub>F</sub>	60	mA
Input	Reverse voltage	V <sub>R</sub>	6	V
	Power Dissipation	P <sub>D</sub>	100	mW
Output	Power dissipation	P <sub>C</sub>	150	mW
	Collector current	Ι <sub>C</sub>	50	mA
	Collector-Emitter voltage	V <sub>CEO</sub>	80	V
	Emitter-Collector voltage	V <sub>ECO</sub>	7	V
Total Power Dissipation		P <sub>TOT</sub>	200	mW
Isolation Voltage*1		V <sub>ISO</sub>	5000	Vrms
Operating Temperature		T <sub>OPR</sub>	-55 to 110	°C
Storage Temperature		T <sub>STG</sub>	-55 to 110	°C
Soldering Temperature* <sup>2</sup>		T <sub>SOL</sub>	260	°C
Opearting humidity		H <sub>OPR</sub>	<75	%R.H.

Notes:

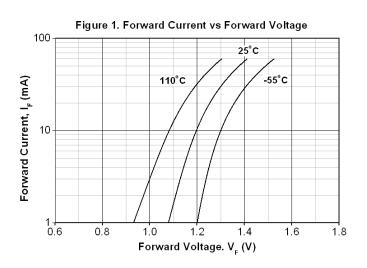
\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together. \*2 For 10 seconds

## **Electro-Optical Characteristics (Ta=25**°C unless specified otherwise)

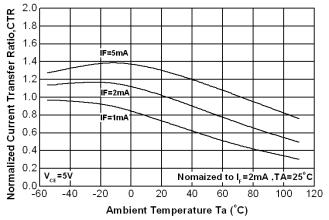
Input						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V <sub>F</sub>	1.01	-	1.29	V	I <sub>F</sub> = 10mA
Reverse Current	I <sub>R</sub>	-	-	9.9	μA	$V_R = 5V$
Output						
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter		-	-	20	nA	$V_{CE} = 5V, I_F = 0mA$
dark current	I <sub>CEO</sub>	-	-	100	nA	$V_{CE} = 24V, I_F = 0mA$
Collector-Emitter breakdown voltage	BV <sub>CEO</sub>	80.1	-	-	V	$I_{\rm C} = 0.1 {\rm mA}$
Emitter-Collector preakdown voltage	BV <sub>ECO</sub>	7.01	-	-	V	I <sub>E</sub> = 0.1mA
Transfer Characte	eristics					
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
		300	-	600	- % ·	$I_F = 5 \text{mA}$ , $V_{CE} = 5 \text{V}$
Current D	- CTR	200	-	500		$I_{\rm F} = 2 {\rm mA}$ , $V_{\rm CE} = 5 {\rm V}$
Transfer ratio		300	-	470		$I_{F} = 5mA$ , $V_{CE} = 5V$
D1		140	-	-		$I_{\rm F} = 1  {\rm mA}  , V_{\rm CE} = 5  {\rm V}$
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	-	-	0.39	V	$I_F = 1mA$ , $I_C = 1mA$
Isolation resistance	R <sub>IO</sub>	1.01×10 <sup>12</sup>	-	-	Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H.
Rise time	t <sub>r</sub>	-	-	12	μs	_
						-
Fall time	t <sub>f</sub>	-	-	12	μs	$V_{\rm CC} = 10V, I_{\rm C} = 2mA,$
Fall time Turn on time	t <sub>f</sub> ton	-	-	12 12	μs μs	$V_{CC} = 10V, I_{C} = 2mA,$ $R_{L} = 100\Omega$

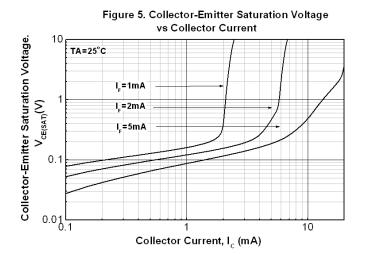
\* Typical values at  $T_a = 25^{\circ}C$ 

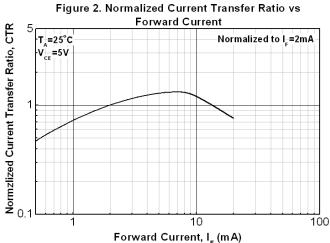
## **Typical Electro-Optical Characteristics Curves**

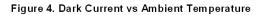


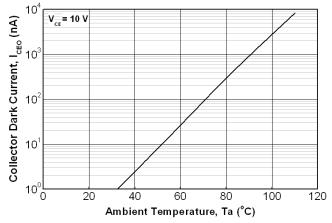




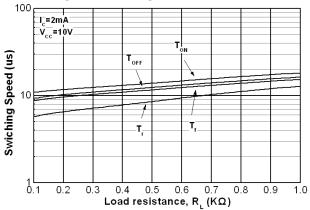


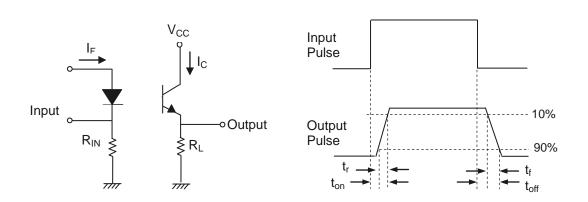












Switching Time Test Circuit & Waveforms

### **Order Information**

Part Number

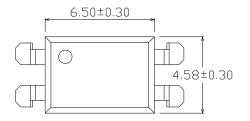
# EL816S1(Y)(Z)(SG)(BY)-VG

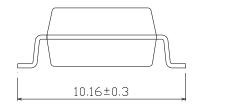
#### Note

- S1 = Lead form option
- Y = CTR Rank
- Z = Tape and reel option (TU, TD).
- V = VDE safety (optional).
- G = Halogens free

Option	Description	Packing quantity	
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel	
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel	

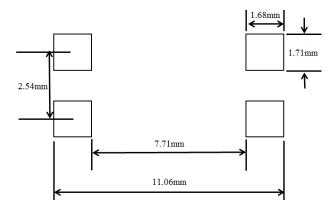
## Package Dimension (Dimensions in mm)







## Recommended pad layout for surface mount leadform



#### Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

## **Device Marking**



#### Notes

- EL denotes EVERLIGHT
- 816 denotes Device Number
- F denotes Factory Code (G: China and Green part)
- R denotes CTR Rank
- Y denotes 1 digit Year code
- WW denotes 2 digit Week code
- V denotes VDE(optional)

## **Tape & Reel Packing Specifications**

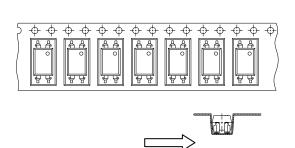
## Option TD

P

Direction of feed from reel

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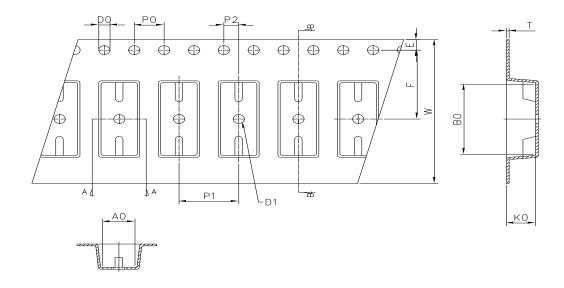
Option TU

Direction of feed from reel

## Tape dimensions

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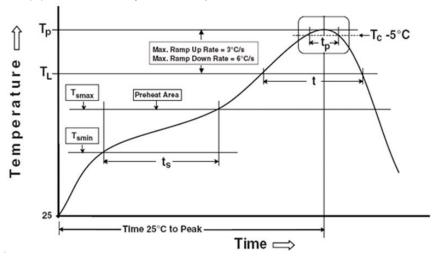


Dimension No.	Ао	Во	Do	D1	E	F
Dimension (mm) S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension No.	Ро	P1	P2	t	W	Ко

#### **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### Preheat

Temperature min (T <sub>smin</sub> )	150 °C
Temperature max (T <sub>smax</sub> )	200°C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds
Average ramp-up rate $(T_{smax} to T_p)$	3 °C/second max
Other	
Liquidus Temperature (TL)	217 °C
Time above Liquidus Temperature (t $_{L}$ )	60-100 sec
Peak Temperature (T <sub>P</sub> )	260°C
Time within 5 °C of Actual Peak Temperature: $T_{\rm P}$ -5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

Reference: IPC/JEDEC J-STD-020D

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